Mr. Li Yang

Tel: +86 18200339516 | E-mail: yl2035197@gmail.com | el21ly@leeds.ac.uk Research Interests: Multimodal learning, Machine Learning, LLM

EDUCATIONAL BACKGROUND

SOUTHWEST JIAOTONG UNIVERSITY(SWJTU) – LEEDS JOINT SCHOOL

Chengdu

B.Sc. Electronic and Electrical Engineering

Sept 2021-Present

GPA: 89.2/100

UNIVERSITY OF LEEDS

Leeds, West Yorkshire

B.Sc. Electronic and Electrical Engineering

Sept 2021- Present

• GPA: 3.64/4.00

PUBLICATIONS

H Luo, Y Zeng, L Yang, K Chen, Z Shen, F Lv (2024). "Vlai: Exploration and Exploitation Based on Visual-Language Aligned Information for Robotic Object Goal Navigation" *Image and Vision Computing*, 2024: 105259.

L, Yang, M Xiong, F Lv, Tianrui Li, F Teng, A Kang, X, Qiu. 2024. Helpfulness Prediction of Review Based on Multiperspective Sub-label Enhancement. China Patent 2024106622191, filed June 1, 2024, and issued September 5, 2024.

RESEARCH PROJECTS

E-commerce Platform Review Quality Analysis

Chengdu

Leader of School Student Research Project (Excellent Project Completion)

May 2023 - May 2024

• Analyzing and ranking the quality of e-commerce platform reviews using convolutional neural networks and attention mechanisms, with performance enhancement through sub-label supervision generated by CLIP.

Candidate Label Pruning in Partial Label Learning via Machine Learning Method

Chengdu

Personal Research Project

Sep 2023 - Apr 2024

- Under the cross-entropy loss function, reducing false ground-truth labels in the candidate label set can significantly improve the efficiency of Partial Label learning.
- Using CLLP to find the cosine similarity between images and labels, and applying the KNN algorithm with this cosine similarity to replace low-similarity false ground-truth labels.

${\bf Enhanced\ Word\ Embeddings\ to\ Mitigate\ the\ Impact\ of\ Spelling\ Errors\ on\ Chinese\ Large\ Models}$

Chengdu

Personal Research Project

Jun 2024 - Present

• Leveraging the characteristic that Chinese characters with similar pictographic features tend to share semantic and phonetic similarities, we designed word embeddings tailored for Chinese large language models that can effectively counteract the interference of spelling errors.

INTERNSHIP EXPERIENCES

North Central Network Chip Limited Company

Chengdu

Chip Verification Engineer

Jul 2022 – Aug 2022

- Gained in-depth knowledge of Verilog and System Verilog languages, along with familiarity with UVM verification platforms, report any error in chip designing, whilst collaborate to solve it in the team.
- Collaborated with a dedicated team to identify and resolve errors in the design of chips.

AWARDS & HONOURS

Service Outsourcing Competition, National Third Prize, Ministry of Education of the PRC	Jul 2024
17th China Undergraduate Computer Design Competition, Province Second Prize	May 2024
Championship in the 2024 "Leeds Cup" Football Competition	Apr 2024
Mingcheng Prize	Oct 2023
SWJTU-Leeds Joint School Third Class Scholarship	Oct 2023
Won the second place in the 2022 " Leeds Cup " Football Competition	Apr 2022
Won Third place in the competition of the 2021 SWJTU "ICBC Cup" Freshman Football Tournament	Oct 2021
Won the second place in the 2021 SWJTU "Yunda Cup" Sports Festival Football Competition	Dec 2021

EXTRACURRICULAR ACTIVITIES

SWJTU - LEEDS JOINT SCHOOL Football Team Captain

May 2022 - May 2024

ADDITIONAL INFORMATION

Skills: C, C++, Python, LaTeX, Verilog, System Verilog **Languages:** Mandarin (Native), English (IELTS – 6.5).

Hobbies: Football (Youth Training in Chengdu Football Association), Tennis (Youth Training), Guitar (Level 7 Certification), etc.